

# VLSI PROJECT REPORT

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2023102066

## I. STRUCTURE OF ADDER

As shown in Fig. 1, the structure of the Carry Look-Ahead Adder (CLA) is detailed below:

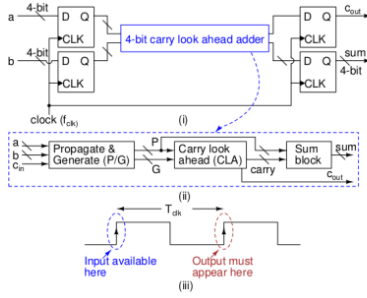


Figure 1

CLA-Adder: If the numbers to be added are  $a_4a_3a_2a_1$  and  $b_4b_3b_2b_1$ , then the propagate ( $p_i$ ) and generate ( $g_i$ ) signals for each bit position can be defined as (for  $i = 1, 2, 3, 4$ )

$$p_i = a_i \oplus b_i$$

$$g_i = a_i \cdot b_i$$

and the carry out ( $c_{i+1}$ ) of the  $i^{th}$  bit position can be written as (assuming  $c_0 = 0$ ) follows:

$$c_{i+1} = (p_i \cdot c_i) + g_i, \quad i = 1, 2, 3, 4$$

Thus,  $c_{i+1}$  can be expressed entirely in terms of the  $p_i$  and  $g_i$  functions and sum can be represented as follows:

$$sum_i = p_i \oplus c_i$$

Fig. 1: Basic structure and working of CLA.

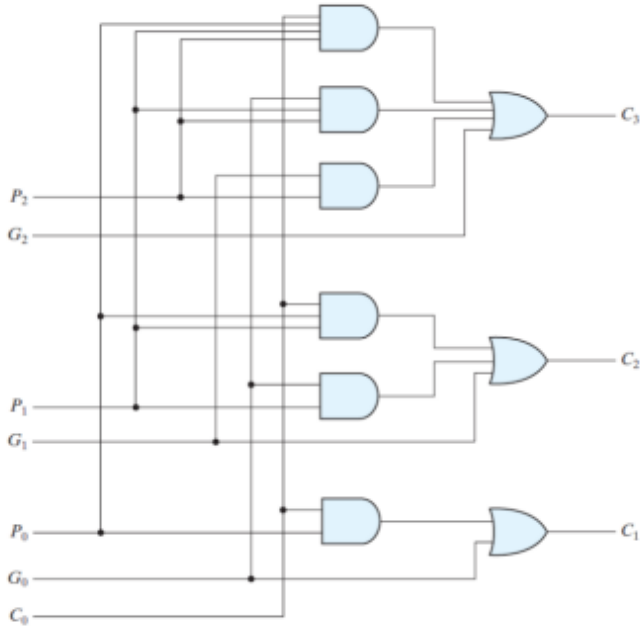


Fig. 2: CLA Generator Logic.

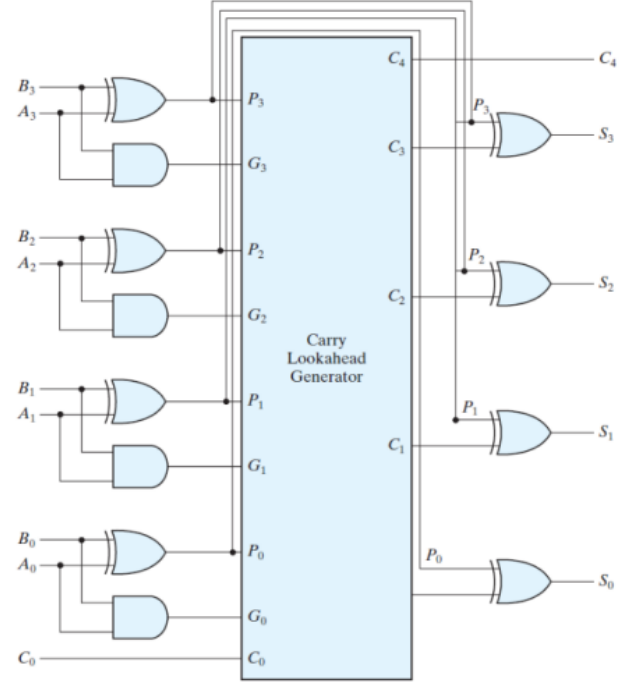


Fig. 3: CLA Adder Logic.

## II. TOPOLOGY AND SIZING OF EACH BLOCK

All gates have been implemented using static CMOS topologies. For Flip-Flops, the True Single-Phase Clocked (TSPC) topology has been utilized. The sizing used for the TSPC Flip-Flop is

$$\frac{20\lambda}{10\lambda}, \quad \text{where } \lambda = 0.09 \mu\text{m}.$$

The sizing used for the gates throughout the circuit is

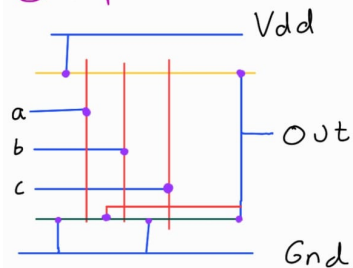
$$\frac{W_p}{W_n} = 2.$$

## III. STICK DIAGRAMS

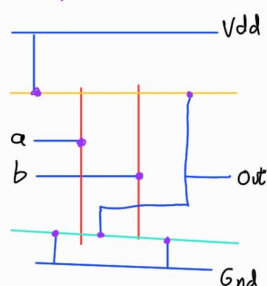
The stick diagrams of gates used are shown below

Polysilicon  
Metal  
Pdiffusion  
Ndiffusion  
Contact

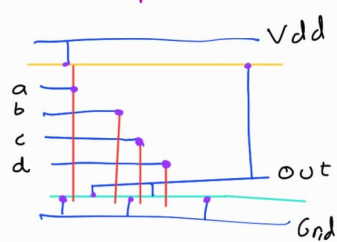
### 3 Input NOR



### 2 Input Nor



### 4 Input NOR



### 5 Input NOR

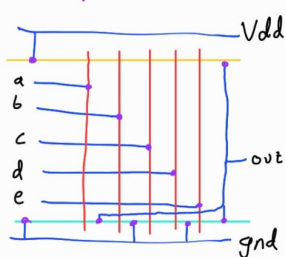
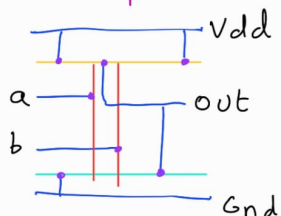
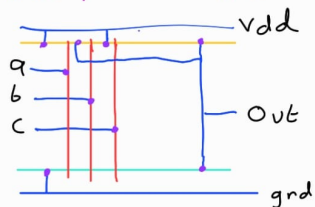


Fig. 4: Enter Caption

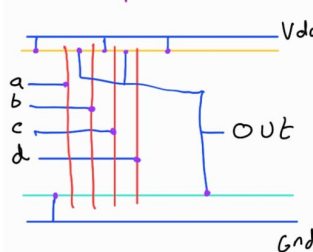
### 2 Input NAND



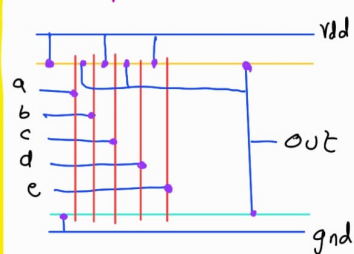
### 3 Input Nand



### 4 Input Nand



### 5 Input Nand



### Inverter :

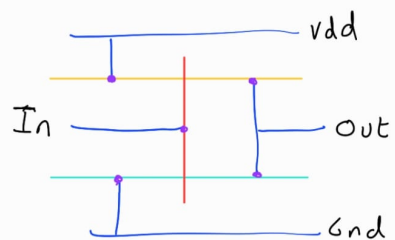
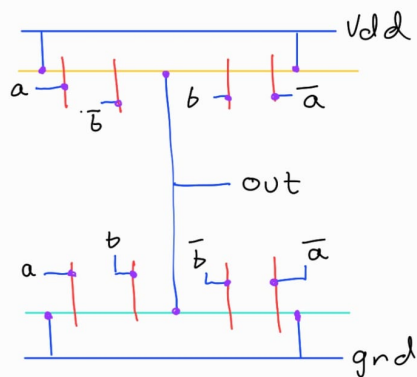


Fig. 5: Enter Caption

### XOR Gate



## IV. NGSPICE SIMULATIONS

### A. Gate Simulations

1) *Inverter*: Inverter implemented using a pmos and nmos connected in series.

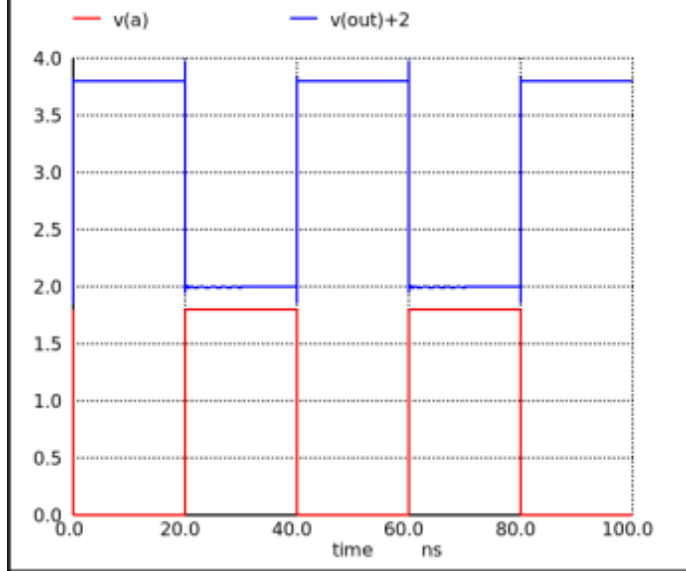


Fig. 7: Inverter Simulation

```

1 .subckt inv x y vdd gnd
2
3 M11 y x gnd gnd CMOS W=(width_N) L=(LAMBDA)
4 + AS=(5*width_N*LAMBDA) PS=(10*LAMBDA+2*width_N) AD=(5*width_N*LAMBDA) PD=(10*LAMBDA+2*width_N)
5 M21 y x vdd vdd CMOS W=(width_P) L=(LAMBDA)
6 + AS=(5*width_P*LAMBDA) PS=(10*LAMBDA+2*width_P) AD=(5*width_P*LAMBDA) PD=(10*LAMBDA+2*width_P)
7 .ends inv
8

```

Fig. 8: Inverter Subckt

2) *AND Gate*: For the two-input AND gate, I have implemented a CMOS style NAND gate connected to an inverter. A CMOS NAND gate uses parallel pMOS transistors in the pull-up network and series nMOS transistors in the pull-down network. The subckt for the NAND gate is shown in Fig. 9 and the simulation for the AND gate is shown in Fig. 10.

```

1
2 .subckt nand A B out vdd gnd
3
4 M1 out A D gnd CMOS W=(2*width_N) L=(2*LAMBDA)
5 + AS=(5*width_N*LAMBDA) PS=(10*LAMBDA+2*width_N) AD=(5*width_N*LAMBDA) PD=(10*LAMBDA+2*width_N)
6
7
8 M2 D B gnd gnd CMOS W=(2*width_N) L=(2*LAMBDA)
9 + AS=(5*width_N*LAMBDA) PS=(10*LAMBDA+2*width_N) AD=(5*width_N*LAMBDA) PD=(10*LAMBDA+2*width_N)
10
11 M3 out A vdd vdd CMOS W=(width_P) L=(2*LAMBDA)
12 + AS=(5*width_P*LAMBDA) PS=(10*LAMBDA+2*width_P) AD=(5*width_P*LAMBDA) PD=(10*LAMBDA+2*width_P)
13
14
15 M4 out B vdd vdd CMOS W=(width_P) L=(2*LAMBDA)
16 + AS=(5*width_P*LAMBDA) PS=(10*LAMBDA+2*width_P) AD=(5*width_P*LAMBDA) PD=(10*LAMBDA+2*width_P)
17
18 *****
19
20 .ends nand
21
22

```

Fig. 9: NAND Gate

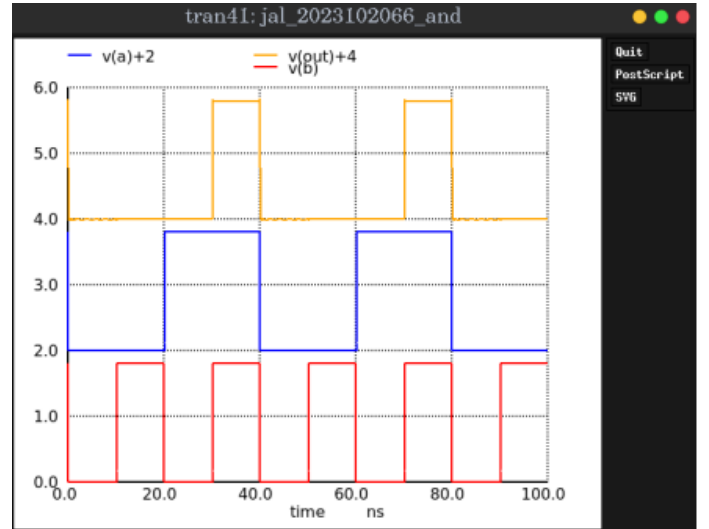


Fig. 10: AND Simulation

3) *OR Gate*: For the two-input OR gate, I have implemented a CMOS style NOR gate connected to an inverter. A CMOS NOR gate uses series pMOS transistors in the pull-up network and parallel nMOS transistors in the pull-down network. The subckt for the NOR gate is shown in Fig. 11 and the simulation for the OR gate is shown in Fig. 12.

```

1
2 .subckt nor A B out vdd gnd
3
4 M1 out A gnd gnd CMOS W=(width_N) L=(2*LAMBDA)
5 + AS=(5*width_N*LAMBDA) PS=(10*LAMBDA+2*width_N) AD=(5*width_N*LAMBDA) PD=(10*LAMBDA+2*width_N)
6
7
8 M2 out B gnd gnd CMOS W=(width_N) L=(2*LAMBDA)
9 + AS=(5*width_N*LAMBDA) PS=(10*LAMBDA+2*width_N) AD=(5*width_N*LAMBDA) PD=(10*LAMBDA+2*width_N)
10
11 M3 out A vdd vdd CMOS W=(2*width_P) L=(2*LAMBDA)
12 + AS=(5*width_P*LAMBDA) PS=(10*LAMBDA+2*width_P) AD=(5*width_P*LAMBDA) PD=(10*LAMBDA+2*width_P)
13
14
15 M4 vdd B vdd vdd CMOS W=(2*width_P) L=(2*LAMBDA)
16 + AS=(5*width_P*LAMBDA) PS=(10*LAMBDA+2*width_P) AD=(5*width_P*LAMBDA) PD=(10*LAMBDA+2*width_P)
17
18 *****
19
20 .ends nor
21
22

```

Fig. 11: NOR subckt

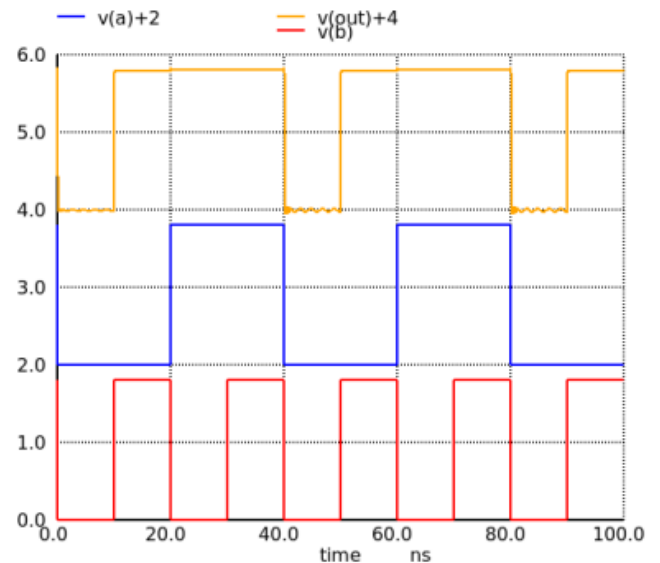


Fig. 12: OR Simulation

4) *XOR Gate*: For the two-input XOR Gate, I have implemented a CMOS style XOR gate. It consists of 4 PMOS transistors in the pull-up network and 4 NMOS transistors in the pull-down network as shown in the stick diagram of the XOR gate.

```

1 .subckt xor A B out vdd gnd
2
3
4 x1 A Abar vdd gnd inv
5 x2 B Bbar vdd gnd inv
6
7 M1 D1 Abar gnd gnd CMOSN W=(2*width_N) L=(2*LAMBDA)
8 + AS=(5*2*width_N*LAMBDA) PS=(10*LAMBDA+2*2*width_N) AD=(5*2*width_N*LAMBDA) PD=(10*LAMBDA+2*2*width_N)
9
10 M2 D2 A gnd gnd CMOSN W=(2*width_N) L=(2*LAMBDA)
11 + AS=(5*2*width_N*LAMBDA) PS=(10*LAMBDA+2*2*width_N) AD=(5*2*width_N*LAMBDA) PD=(10*LAMBDA+2*2*width_N)
12
13 M3 out Bbar D1 D1 CMOSN W=(2*width_N) L=(2*LAMBDA)
14 + AS=(5*2*width_N*LAMBDA) PS=(10*LAMBDA+2*2*width_N) AD=(5*2*width_N*LAMBDA) PD=(10*LAMBDA+2*2*width_N)
15
16 M4 out B D2 D2 CMOSN W=(2*width_N) L=(2*LAMBDA)
17 + AS=(5*2*width_N*LAMBDA) PS=(10*LAMBDA+2*2*width_N) AD=(5*2*width_N*LAMBDA) PD=(10*LAMBDA+2*2*width_N)
18
19
20
21 M5 out Bbar S1 S1 CMOSN W=(2*width_P) L=(2*LAMBDA)
22 + AS=(5*2*width_P*LAMBDA) PS=(10*LAMBDA+2*2*width_P) AD=(5*2*width_P*LAMBDA) PD=(10*LAMBDA+2*2*width_P)
23
24 M6 out B S2 S2 CMOSN W=(2*width_P) L=(2*LAMBDA)
25 + AS=(5*2*width_P*LAMBDA) PS=(10*LAMBDA+2*2*width_P) AD=(5*2*width_P*LAMBDA) PD=(10*LAMBDA+2*2*width_P)
26
27
28 M7 S1 A vdd vdd CMOSN W=(2*width_P) L=(2*LAMBDA)
29 + AS=(5*2*width_P*LAMBDA) PS=(10*LAMBDA+2*2*width_P) AD=(5*2*width_P*LAMBDA) PD=(10*LAMBDA+2*2*width_P)
30
31 M8 S2 Abar vdd vdd CMOSN W=(2*width_P) L=(2*LAMBDA)
32 + AS=(5*2*width_P*LAMBDA) PS=(10*LAMBDA+2*2*width_P) AD=(5*2*width_P*LAMBDA) PD=(10*LAMBDA+2*2*width_P)
33

```

Fig. 13: XOR subckt

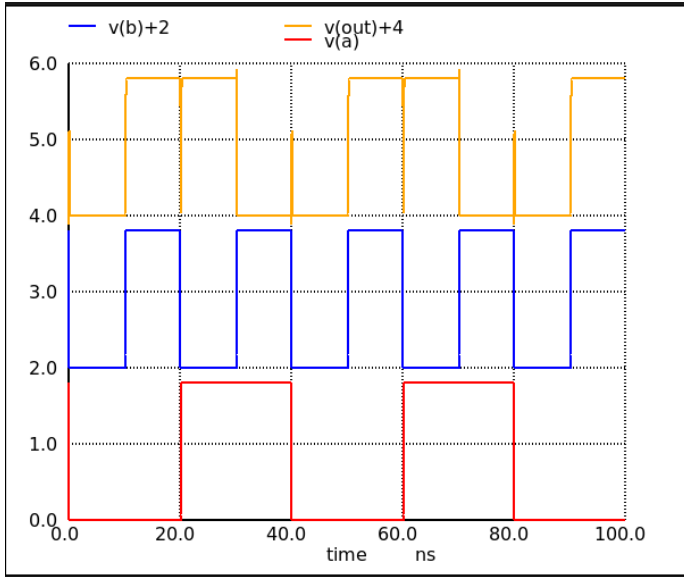


Fig. 14: XOR Simulation

5) *Flip-Flop*: For the flip-flop, I chose the True Single Phase Clock (TSPC) topology since it's fast and has zero hold time. Its circuit can be seen in the figure below. We connect the output of the negative latch with input of the positive latch to make positive edge triggered flip flop.

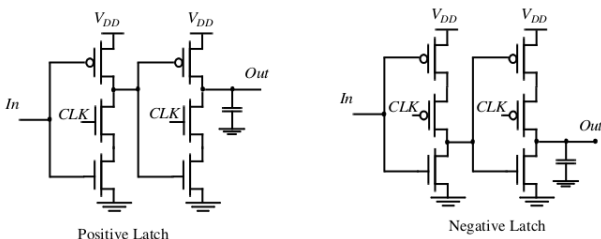


Figure 7.30 True Single Phase Latches.

Fig. 15: TSPC Latches

```

1 .subckt tpsc D Q clk vdd gnd
2
3 M3 D1 D vdd vdd CMOSN W=(2*width_P) L=(2*LAMBDA)
4 + AS=(5*width_P*LAMBDA) PS=(10*LAMBDA+2*width_P) AD=(5*width_P*LAMBDA) PD=(10*LAMBDA+2*width_P)
5
6
7 M4 B clk D1 vdd CMOSN W=(2*width_P) L=(2*LAMBDA)
8 + AS=(5*width_P*LAMBDA) PS=(10*LAMBDA+2*width_P) AD=(5*width_P*LAMBDA) PD=(10*LAMBDA+2*width_P)
9
10
11 M2 B D gnd gnd CMOSN W=(width_N) L=(2*LAMBDA)
12 + AS=(5*width_N*LAMBDA) PS=(10*LAMBDA+2*width_N) AD=(5*width_N*LAMBDA) PD=(10*LAMBDA+2*width_N)
13
14 M1 D11 B vdd vdd CMOSN W=(2*width_P) L=(2*LAMBDA)
15 + AS=(5*width_P*LAMBDA) PS=(10*LAMBDA+2*width_P) AD=(5*width_P*LAMBDA) PD=(10*LAMBDA+2*width_P)
16
17
18 M5 out1 clk D11 vdd CMOSN W=(width_P) L=(2*LAMBDA)
19 + AS=(5*width_P*LAMBDA) PS=(10*LAMBDA+2*width_P) AD=(5*width_P*LAMBDA) PD=(10*LAMBDA+2*width_P)
20
21 M6 out1 B gnd gnd CMOSN W=(width_N) L=(2*LAMBDA)
22 + AS=(5*width_N*LAMBDA) PS=(10*LAMBDA+2*width_N) AD=(5*width_N*LAMBDA) PD=(10*LAMBDA+2*width_N)
23
24
25 M7 D3 out1 gnd gnd CMOSN W=(width_N) L=(2*LAMBDA)
26 + AS=(5*width_N*LAMBDA) PS=(10*LAMBDA+2*width_N) AD=(5*width_N*LAMBDA) PD=(10*LAMBDA+2*width_N)
27
28 M8 A clk D3 gnd CMOSN W=(2*width_N) L=(2*LAMBDA)
29 + AS=(5*width_N*LAMBDA) PS=(10*LAMBDA+2*width_N) AD=(5*width_N*LAMBDA) PD=(10*LAMBDA+2*width_N)
30
31 M9 A out1 vdd vdd CMOSN W=(width_P) L=(2*LAMBDA)
32 + AS=(5*width_P*LAMBDA) PS=(10*LAMBDA+2*width_P) AD=(5*width_P*LAMBDA) PD=(10*LAMBDA+2*width_P)
33
34 M10 Q A vdd vdd CMOSN W=(width_P) L=(2*LAMBDA)
35 + AS=(5*width_P*LAMBDA) PS=(10*LAMBDA+2*width_P) AD=(5*width_P*LAMBDA) PD=(10*LAMBDA+2*width_P)
36
37 M11 Q clk D4 gnd CMOSN W=(2*width_N) L=(2*LAMBDA)
38 + AS=(5*width_N*LAMBDA) PS=(10*LAMBDA+2*width_N) AD=(5*width_N*LAMBDA) PD=(10*LAMBDA+2*width_N)
39
40 M12 D4 A gnd gnd CMOSN W=(2*width_N) L=(2*LAMBDA)
41 + AS=(5*width_N*LAMBDA) PS=(10*LAMBDA+2*width_N) AD=(5*width_N*LAMBDA) PD=(10*LAMBDA+2*width_N)
42
43 .ends tpsc

```

Fig. 16: TSPC subckt

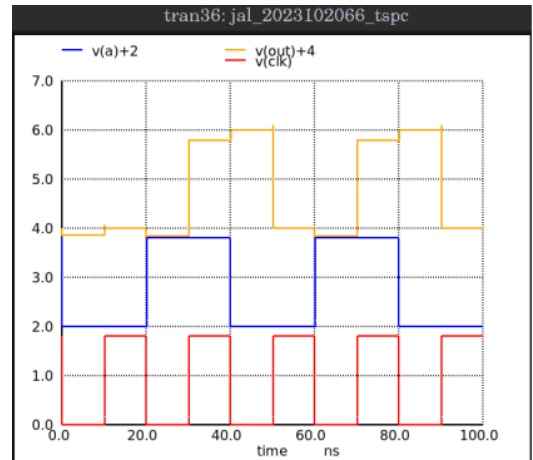


Fig. 17: TSPC Simulation

## B. Block Simulations

1) *Propagate and Generate Block*: The subckt and simulation for png block is shown. This block generates propagate(p) and generate (g) which are necessary for cla generator block.

```

1 .subckt png A B p g vdd gnd
2
3 * x4 A Abar vdd gnd inv
4 * x5 B bbar vdd gnd inv
5 x1 A B p vdd gnd xor
6 x2 A B g1 vdd gnd nand
7 x3 g1 g vdd gnd inv
8 .ends png

```

Fig. 18: png subckt

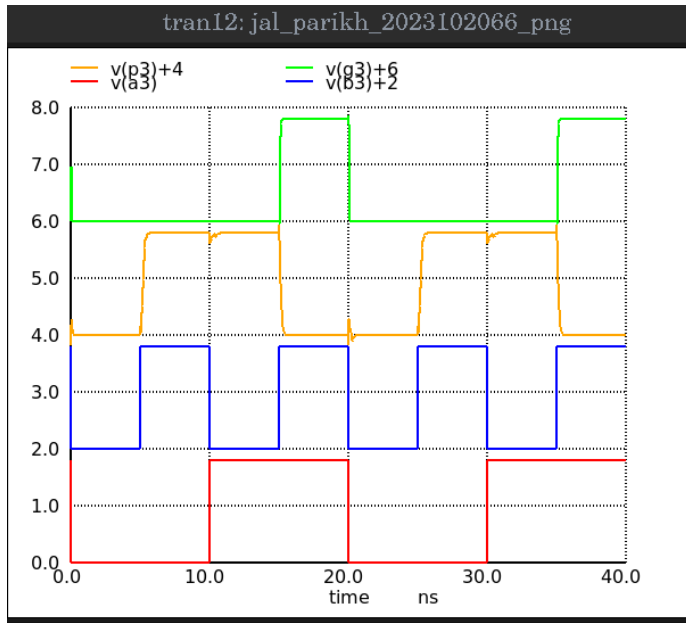


Fig. 19: png simulation

2) *CLA Generator*: This block generates the carry. The formula for all different carry is given by:

$$C_1 = G_0 + P_0 C_{in}$$

$$C_2 = G_1 + P_1 C_1$$

$$= G_1 + P_1 G_0 + P_1 P_0 C_{in}$$

$$C_3 = G_2 + P_2 C_2$$

$$= G_2 + P_2 G_1 + P_2 P_1 G_0 + P_2 P_1 P_0 C_{in}$$

$$C_4 = G_3 + P_3 C_3$$

$$= G_3 + P_3 G_2 + P_3 P_2 G_1 + P_3 P_2 P_1 G_0 + P_3 P_2 P_1 P_0 C_{in}$$

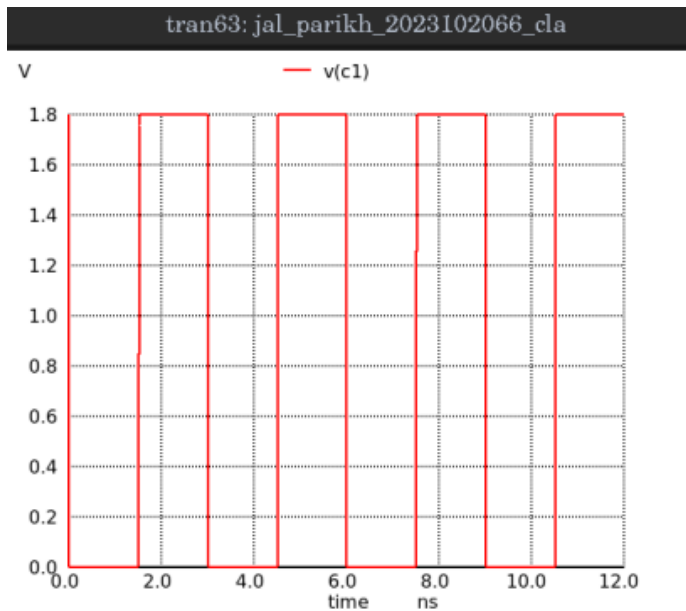


Fig. 20: Cin

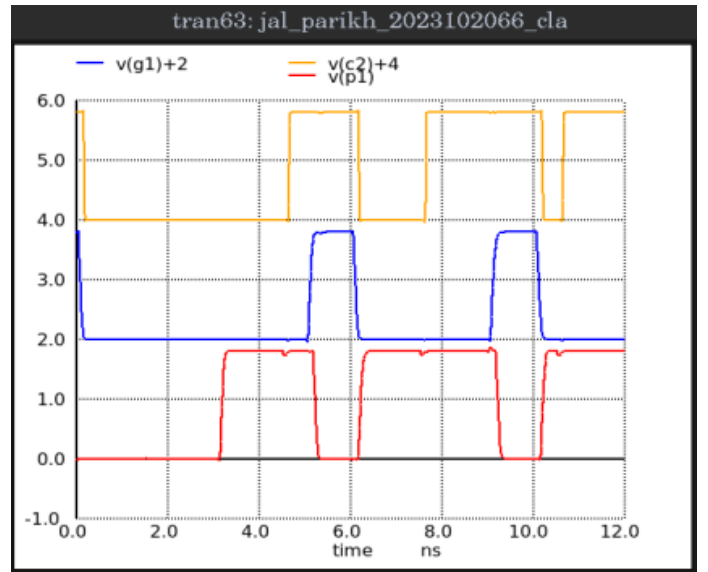


Fig. 21: C2

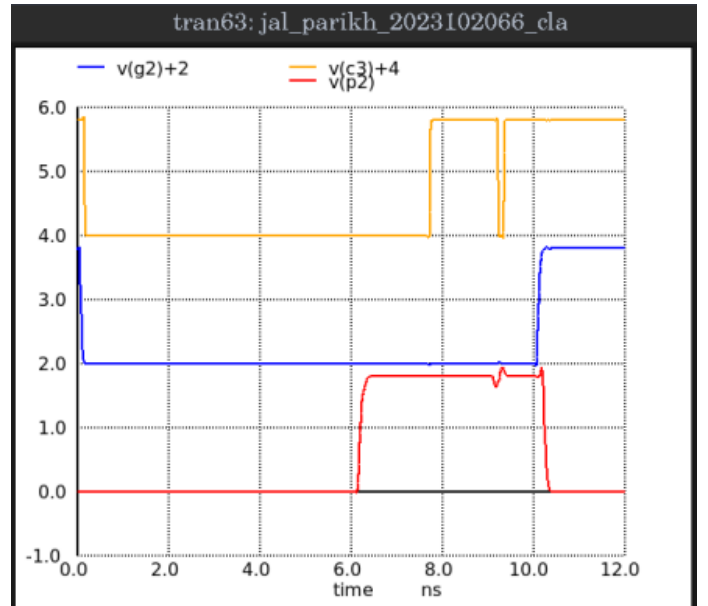


Fig. 22: C3

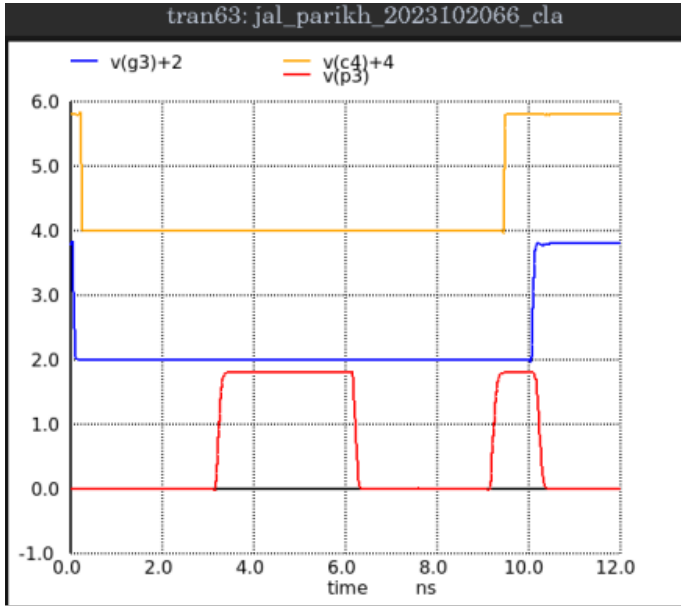


Fig. 23: C4

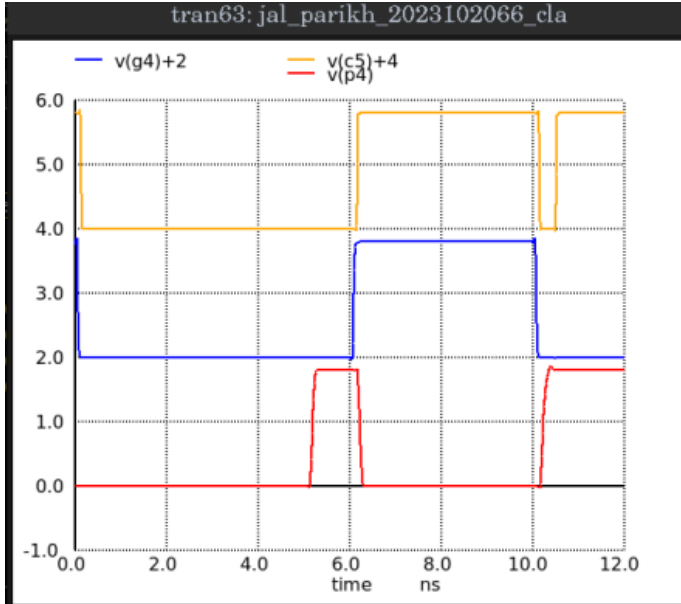


Fig. 24: Cout

3) *Sum block*: This block gives the final output. The simulations are provided in fig 24, 25 26, 27.

$$\begin{array}{rcccc}
 & a_4 & a_3 & a_2 & a_1 \\
 + & b_4 & b_3 & b_2 & b_1 \\
 \hline
 c_5 & s_4 & s_3 & s_2 & s_1
 \end{array}$$

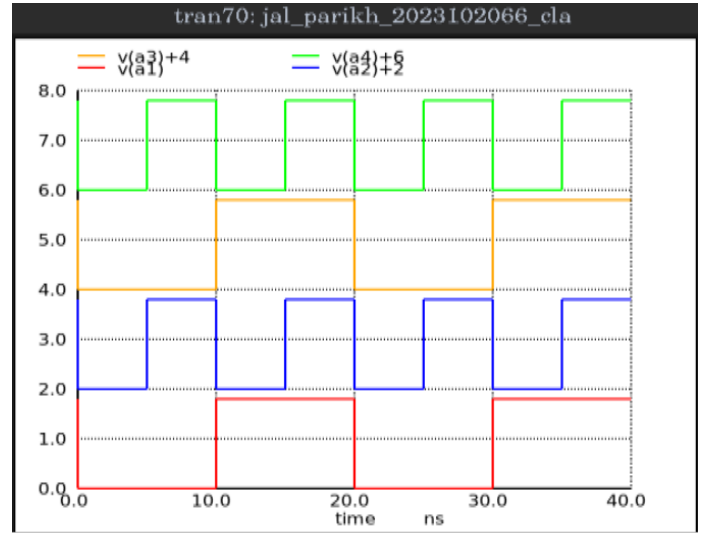


Fig. 25: Input A

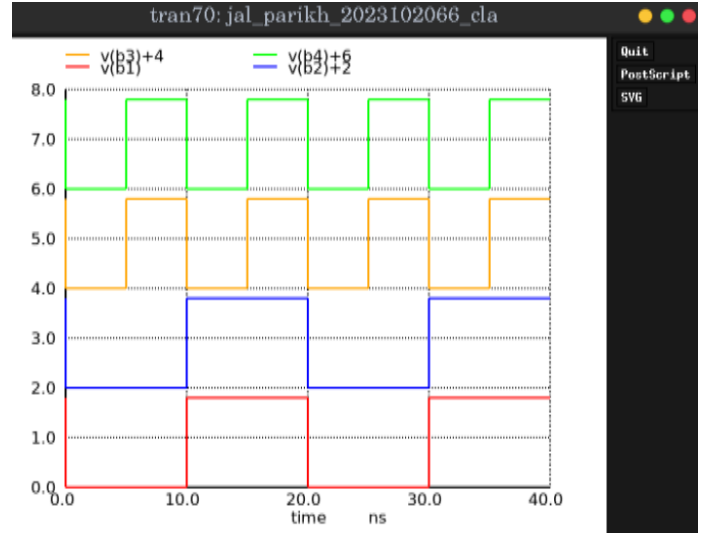


Fig. 26: Input B

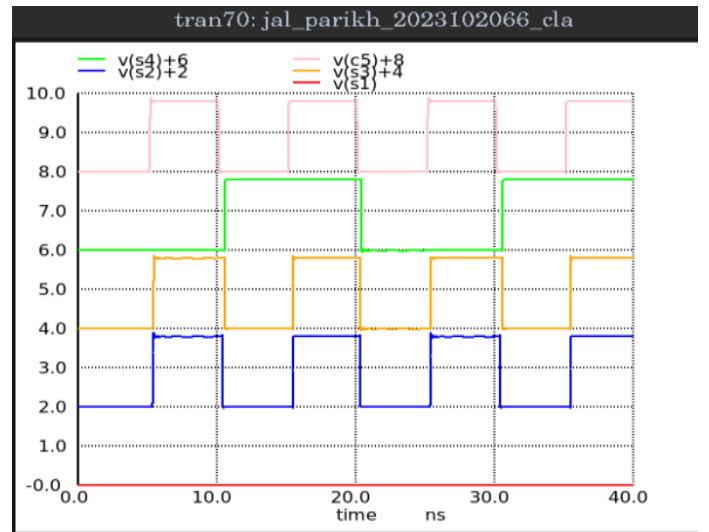


Fig. 27: Sum output

```

2 .include TSMC_180nm.txt
3 .include nor.sub
4 .include inv.sub
5 .include nand.sub
6 .include xor.sub
7 .include png.sub
8 .include or.sub
9 .include and.sub
10 .include clagen.sub
11 .include png.sub
12 .include tpe.sub
13
14
15
16 .param SUPPLY=1.8
17 .param LAMBDA=0.09u
18 .global gnd vdd
19
20 vdd vdd gnd 'SUPPLY'
21
22 .param width_Pc(20*LAMBDA)
23 .param width_Nc(10*LAMBDA)
24
25
26 x1 A1 B1 p1 g1 vdd gnd png
27 x2 A2 B2 p2 g2 vdd gnd png
28 x3 A3 B3 p3 g3 vdd gnd png
29 x4 A4 B4 p4 g4 vdd gnd png
30
31 x5 p1 p2 p3 p4 g1 g2 g3 g4 c1 c2 c3 c4 c5 vdd gnd clagen
32
33
34 x6 C1 p1 s1 vdd gnd xor
35 x7 C2 p2 s2 vdd gnd xor
36 x8 C3 p3 s3 vdd gnd xor
37 x9 C4 p4 s4 vdd gnd xor
38 vcin c1 gnd 0
39 * vcin c1 gnd pulse 1.0 0 0ns 10ps 10ps 1.5ns 3ns
40 vA1 A1 gnd pulse 1.0 0 0ns 10ps 10ps 10ns 20ns
41 vA2 A2 gnd pulse 1.0 0 0ns 10ps 10ps 5ns 10ns
42 vA3 A3 gnd pulse 1.0 0 0ns 10ps 10ps 10ns 20ns
43 vA4 A4 gnd pulse 1.0 0 0ns 10ps 10ps 5ns 10ns
44 vB1 B1 gnd pulse 1.0 0 0ns 10ps 10ps 10ns 20ns
45 vB2 B2 gnd pulse 1.0 0 0ns 10ps 10ps 10ns 20ns
46 vB3 B3 gnd pulse 1.0 0 0ns 10ps 10ps 5ns 10ns

```

Fig. 28: Sum Subckt

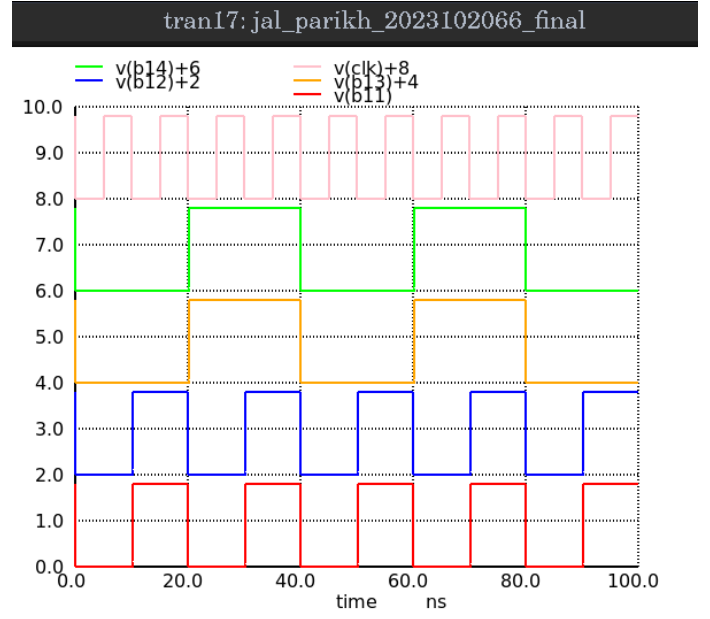


Fig. 30: Input B

### C. Final Circuit

After adding flipflops to input and output bits, my circuit follows clock and output bits arrive at next rising edge of the cycle as shown in Fig. 28, 29, 30.

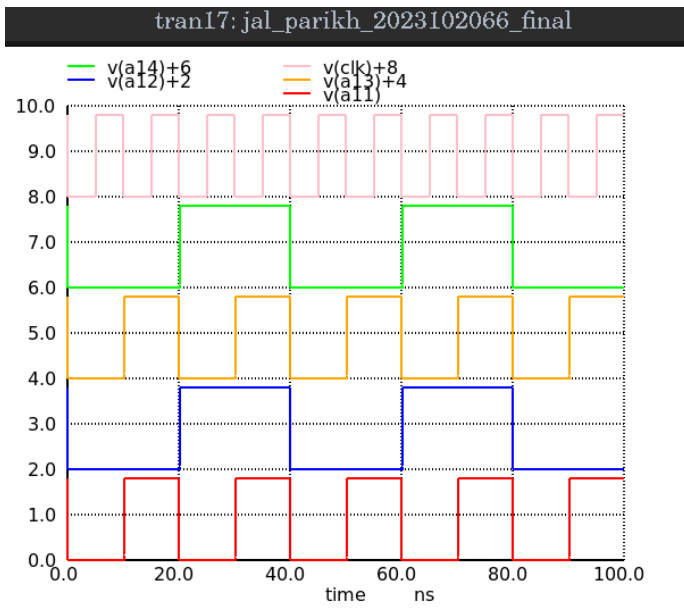


Fig. 29: Input A

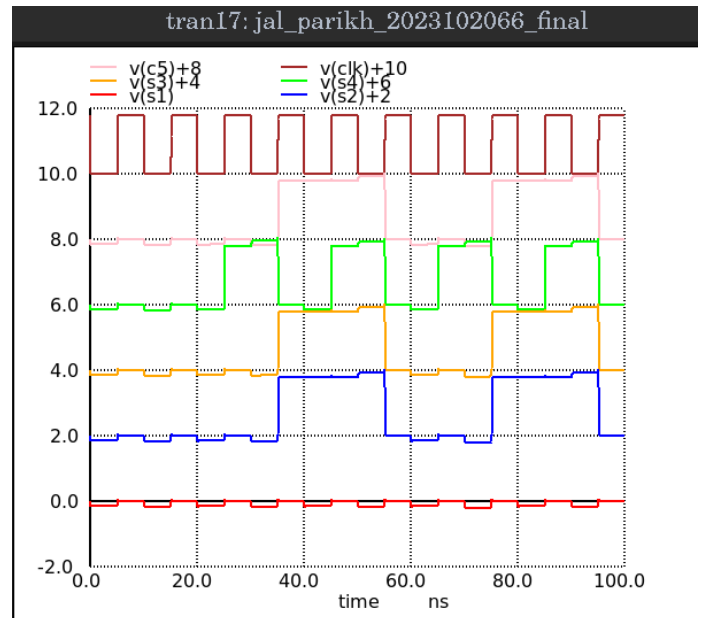


Fig. 31: sum bits



## V. MAGIC LAYOUT

### A. Gates

Layout for all gates are shown below

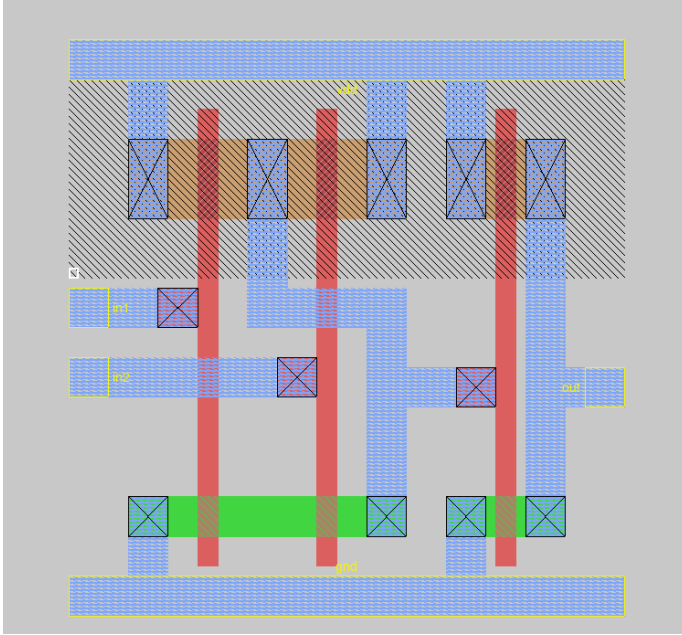


Fig. 32: And Gate

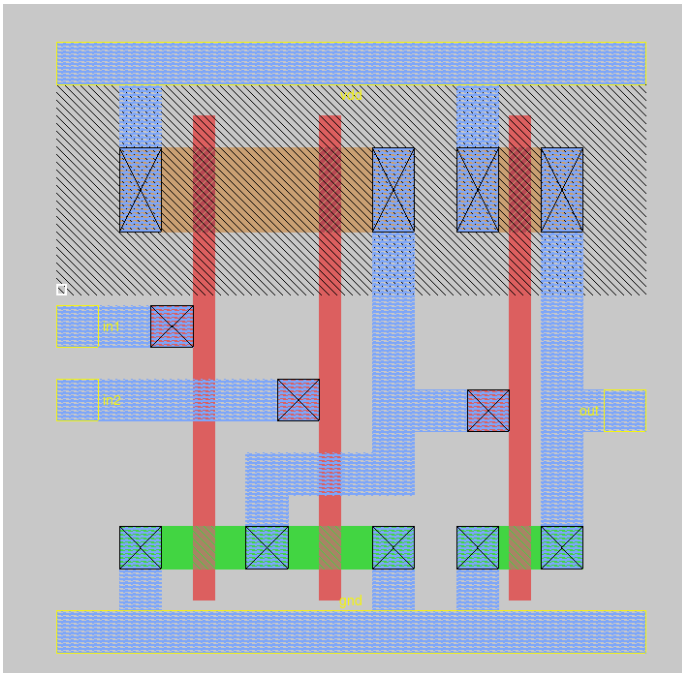


Fig. 33: Or Gate

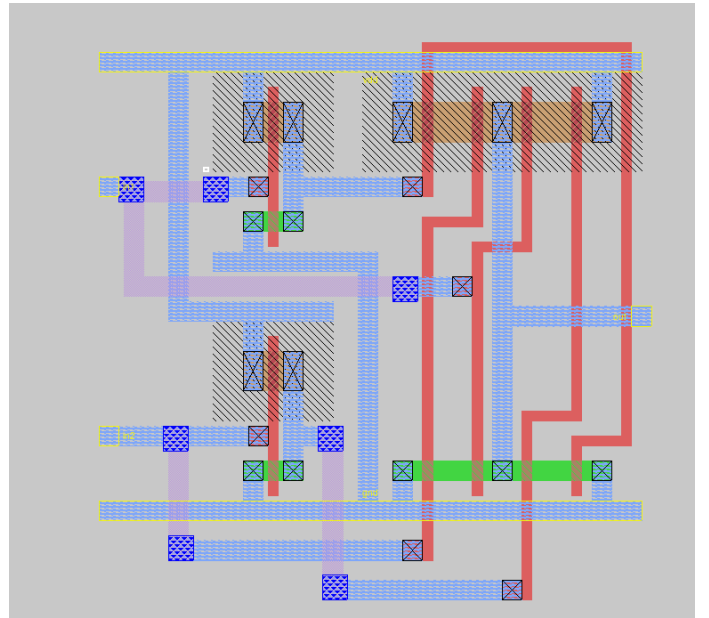


Fig. 34: Xor Gate

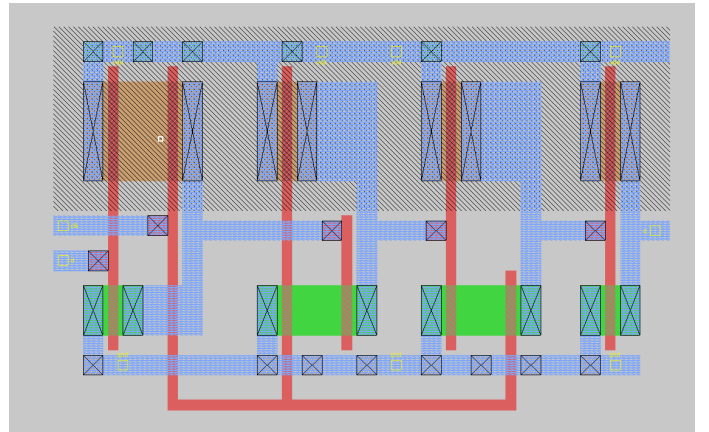


Fig. 35: TSPC flipflop

### B. Blocks

Layout for the blocks are:

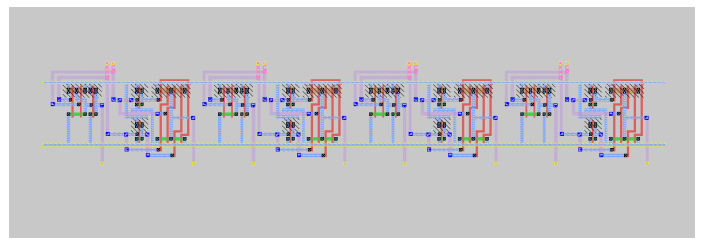


Fig. 36: png block



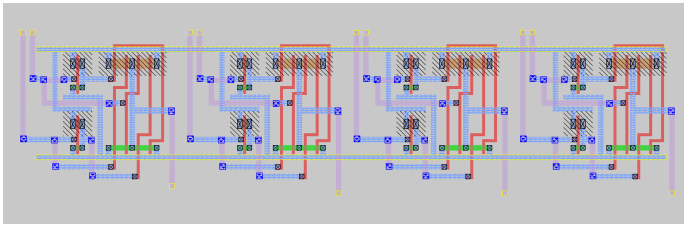


Fig. 37: sum block

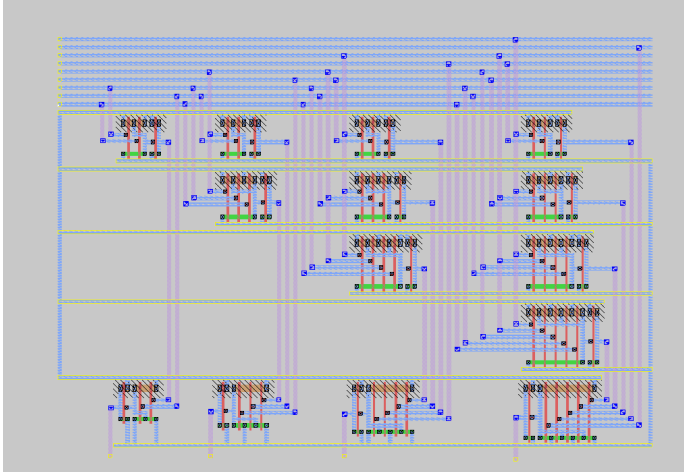


Fig. 38: Cla generator block

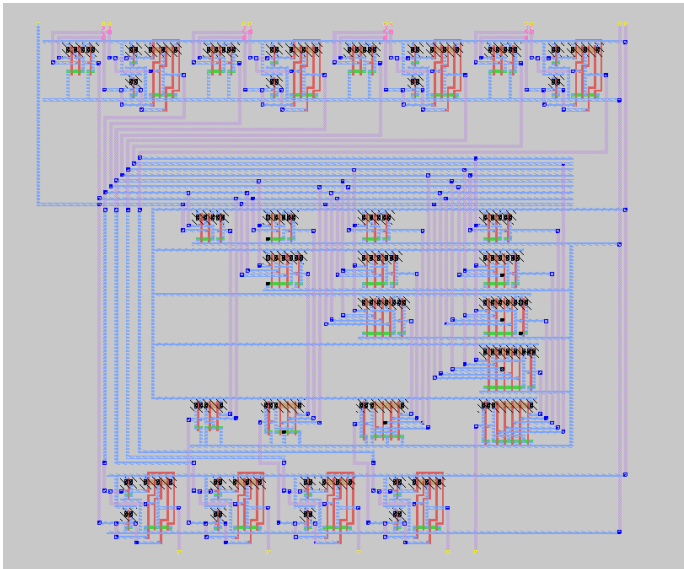


Fig. 39: Adder Block(All 3 combined)

### C. Floor Plan of the Layout

```
Root cell box:
  width x height ( llx, lly ), ( urx, ury )
  area (units^2)

microns: 0.09 x 0.09 ( 0.00, 0.00 ), ( 0.09,
0.09 ) 0.01
lambda: 1 x 1 ( 0, 0 ), ( 1, 1 ) 1

Main console display active (Tcl8.6.13 / Tk8
.6.13)
select: Topmost cell in the window

Root cell box:
  width x height ( llx, lly ), ( urx, ury )
  area (units^2)

microns: 88.74 x 111.69 ( -130.05, 28.53), (
-41.31, 140.22) 9911.37
lambda: 986 x 1241 ( -1445, 317 ), ( -459, 1558 )
1223626
```

```
Root cell box:
  width x height ( llx, lly ), ( urx, ury ) area (units^2)
microns: 0.09 x 0.09 ( 0.00, 0.00 ), ( 0.09, 0.09 ) 0.01
lambda: 1 x 1 ( 0, 0 ), ( 1, 1 ) 1
Main console display active (Tcl8.6.13 / Tk8.6.13)
select: Topmost cell in the window
Root cell box:
  width x height ( llx, lly ), ( urx, ury ) area (units^2)
microns: 88.74 x 111.69 ( -130.05, 28.53), ( -41.31, 140.22) 9911.37
lambda: 986 x 1241 ( -1445, 317 ), ( -459, 1558 ) 1223626
```

Fig. 40: Floor plan

VI. POST LAYOUT SIMULATIONS

A. Gates

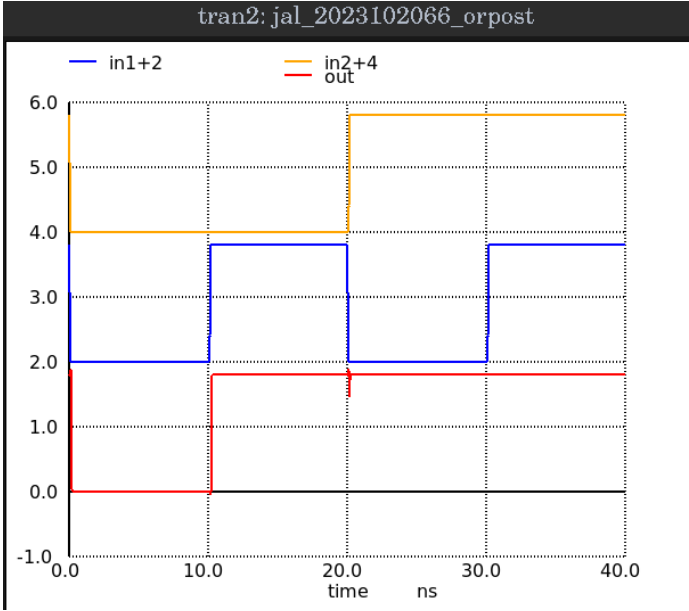


Fig. 41: post layout Or gate simulation

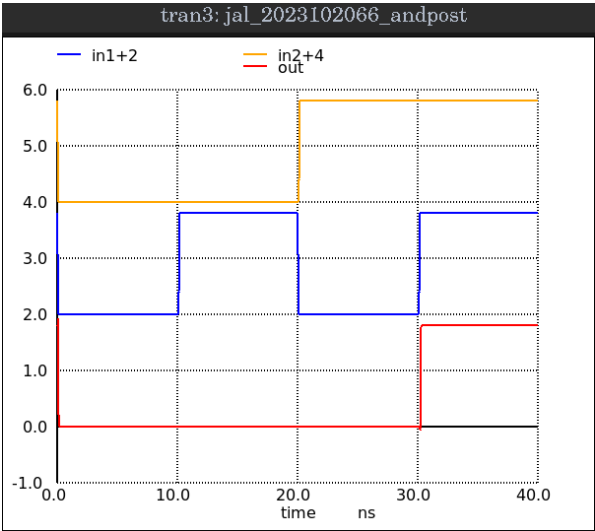


Fig. 42: Post layout AND gate simulation

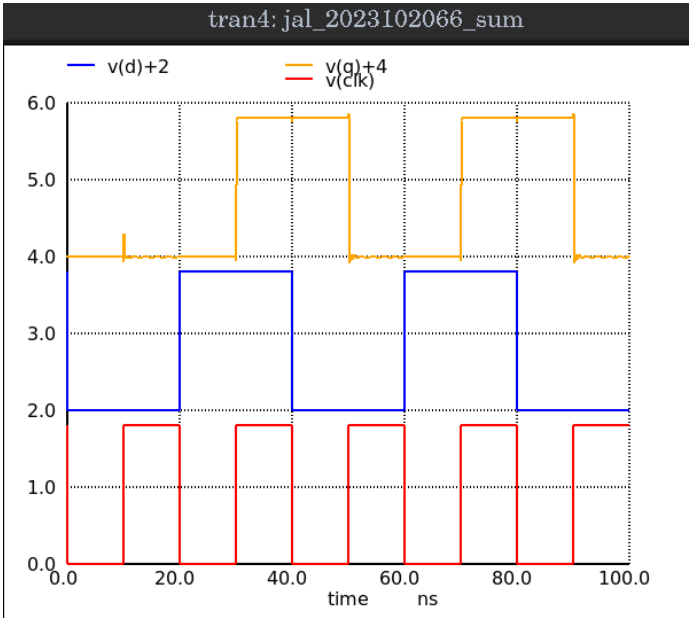


Fig. 43: post layout TSPC flipflop simulation

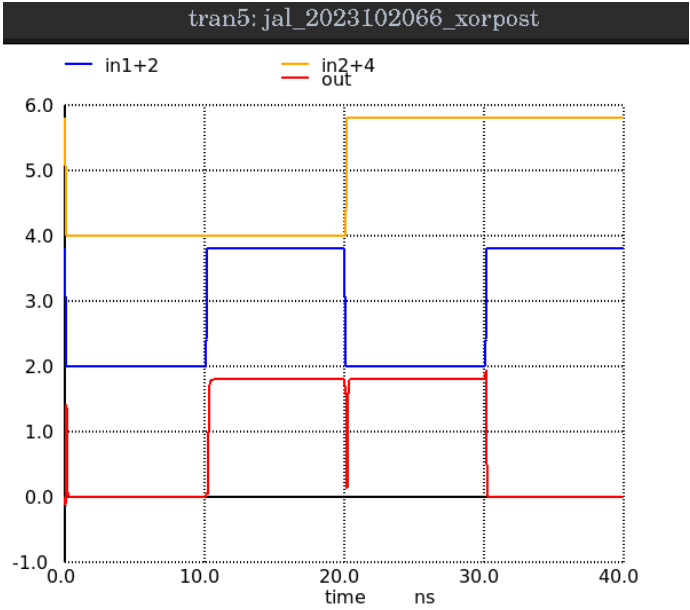


Fig. 44: post layout XOR gate simulation

## B. Blocks

1) *png block*: The simulations of p3 and g3 are shown in fig 40. Other Pi and Gi are similar to this.

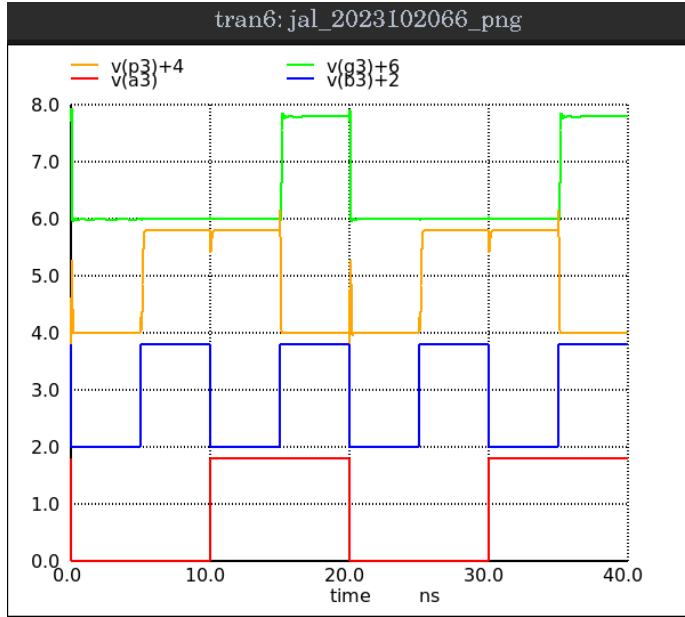


Fig. 45: post layout simulation of png block

2) *CLA gen outputs*: The simulations of Cin,C1,C2,C3,C4 are shown in fig 45-49.

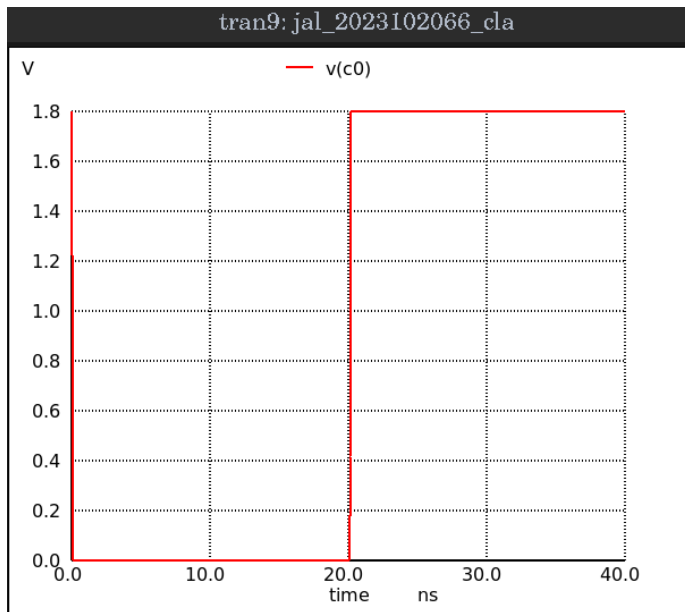


Fig. 46: Cin

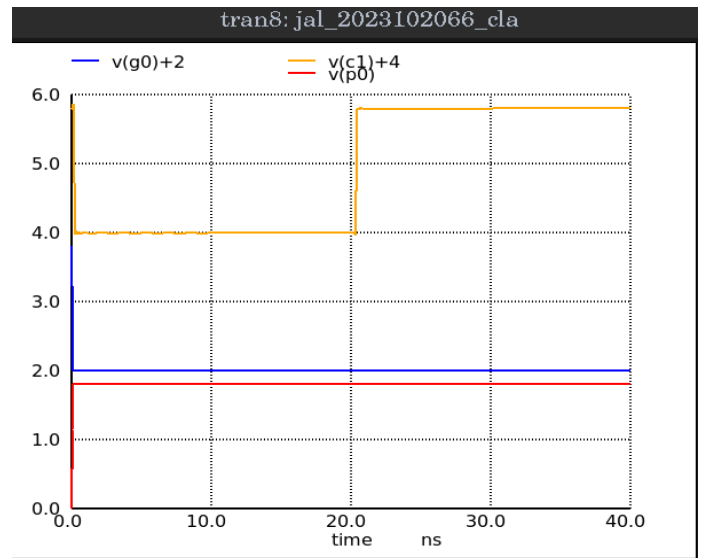


Fig. 47: C1

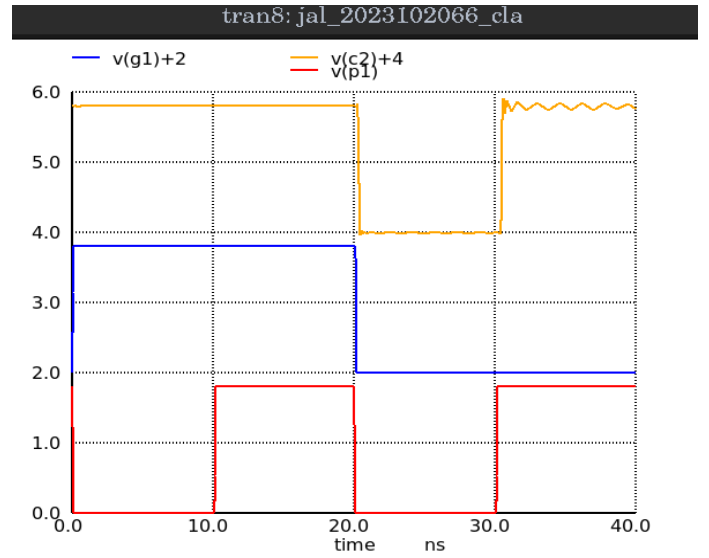


Fig. 48: C2

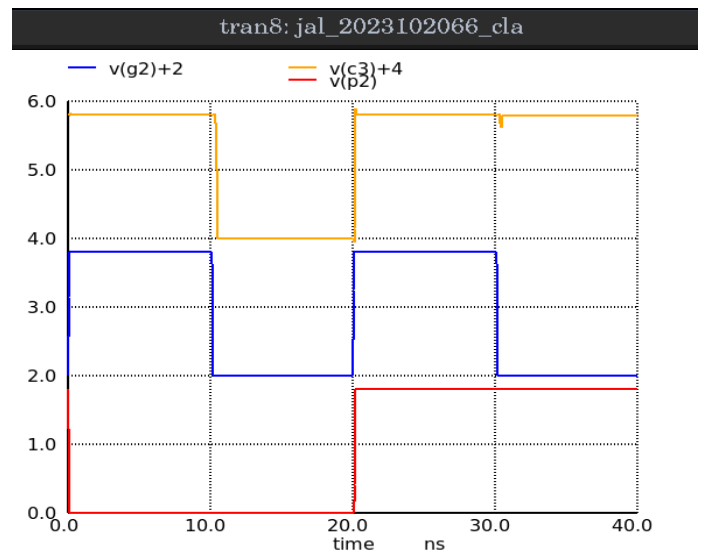


Fig. 49: C3

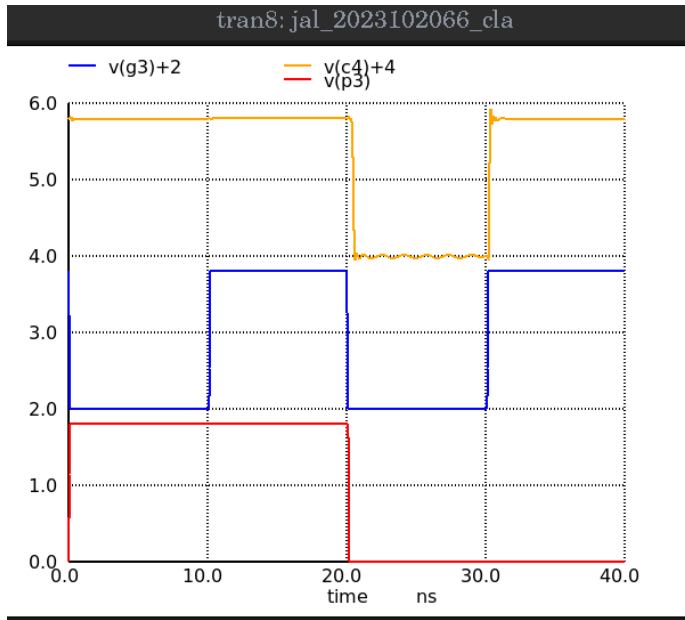


Fig. 50: Cout

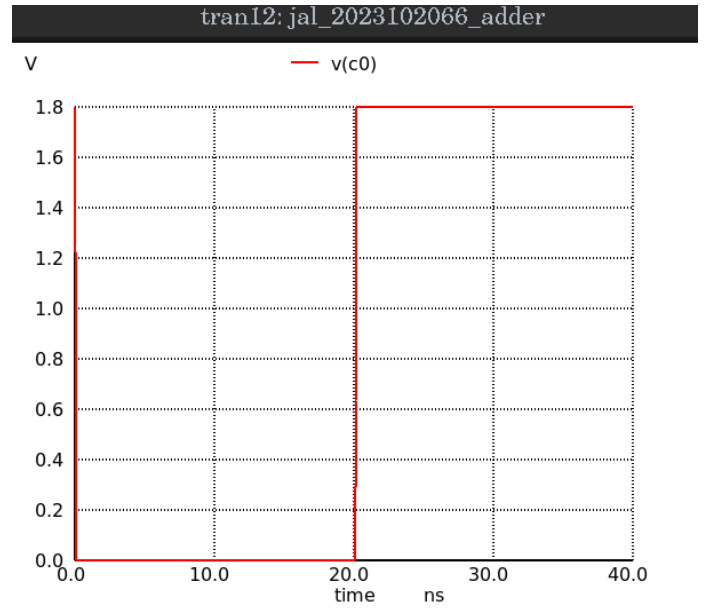


Fig. 52: Cin

3) *Sum Block*: For sum block, we need P and C only as seen in the diagram earlier. Simulation for S2 is shown here, other follow the same type.

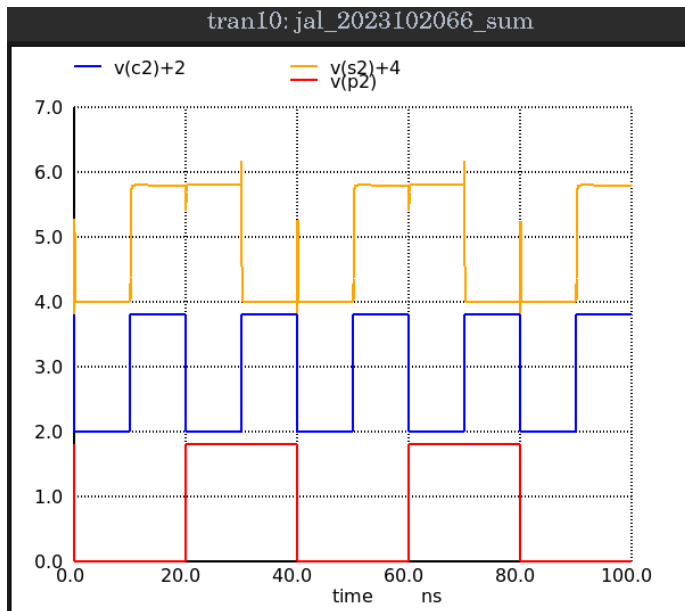


Fig. 51: post layout simulation of sum block

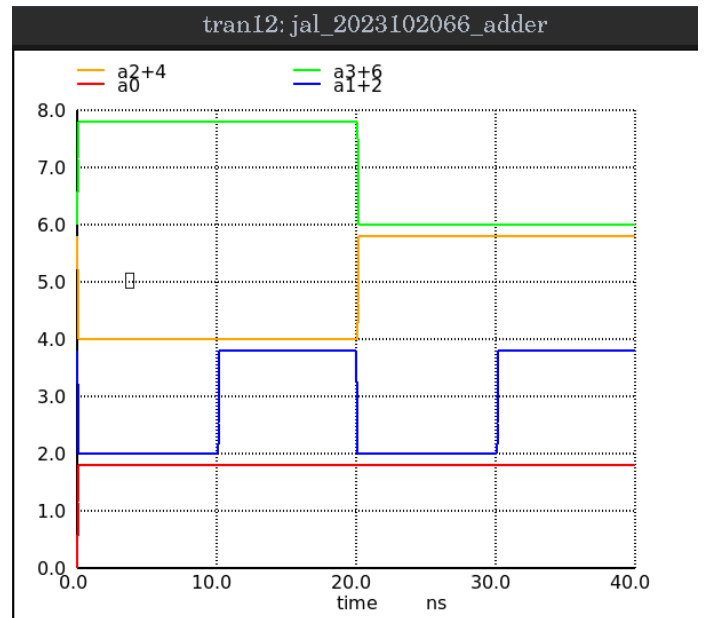
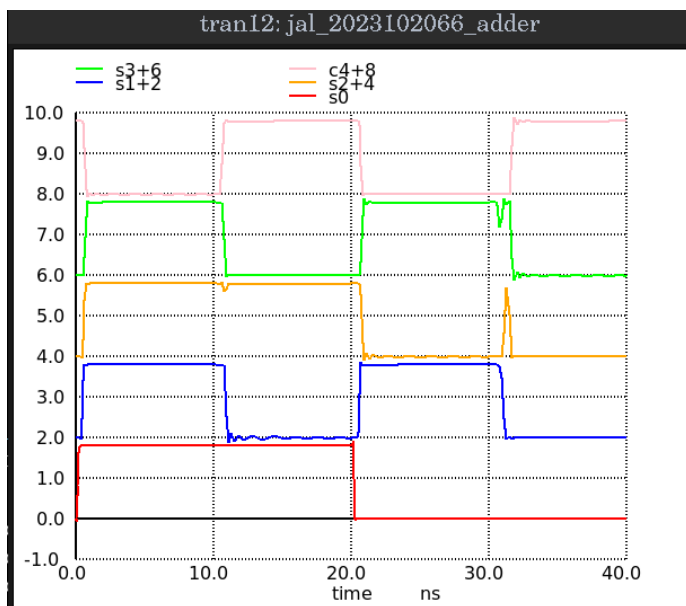
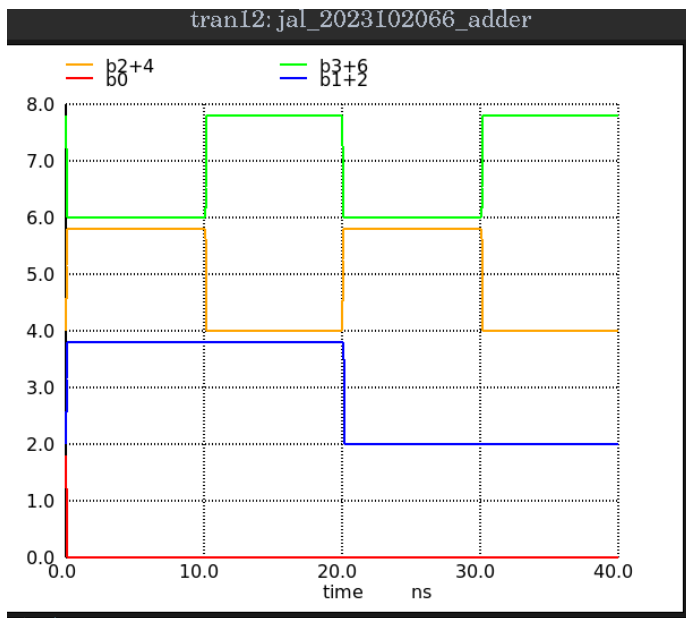
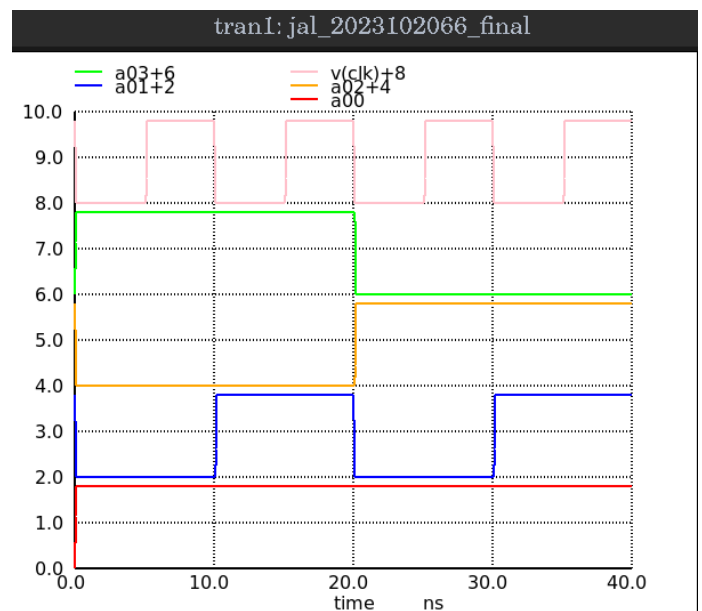
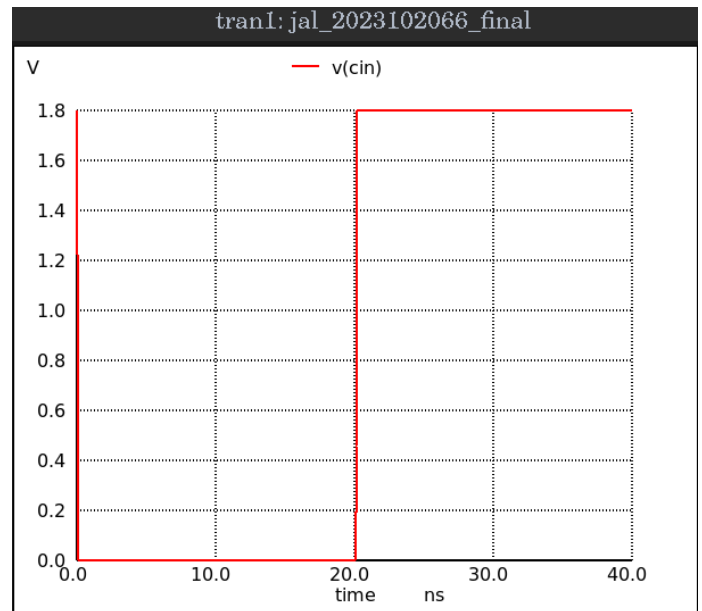


Fig. 53: Input A

4) *Adder block - All 3 combined*: Post layout simulations of adder block without using flipflops are shown in fig 51-54.



5) *Final Block:* The post layout simulations after adding flipflops and connecting all blocks are shown below



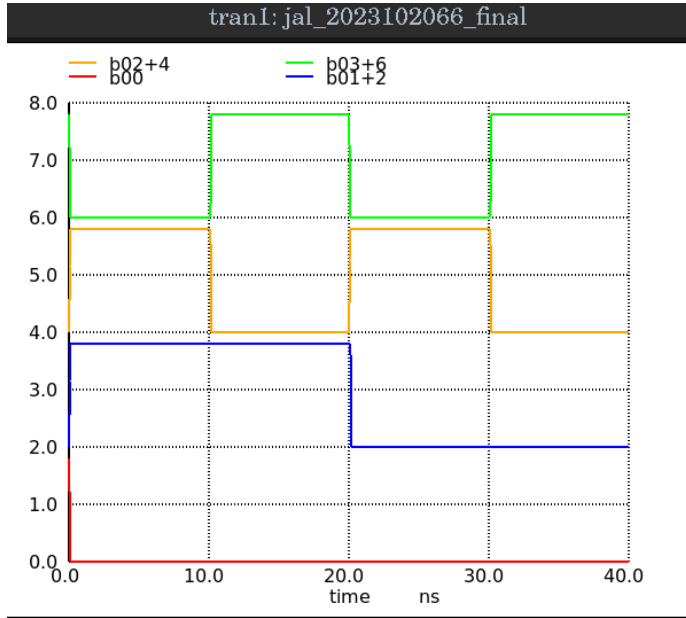


Fig. 58: Input B

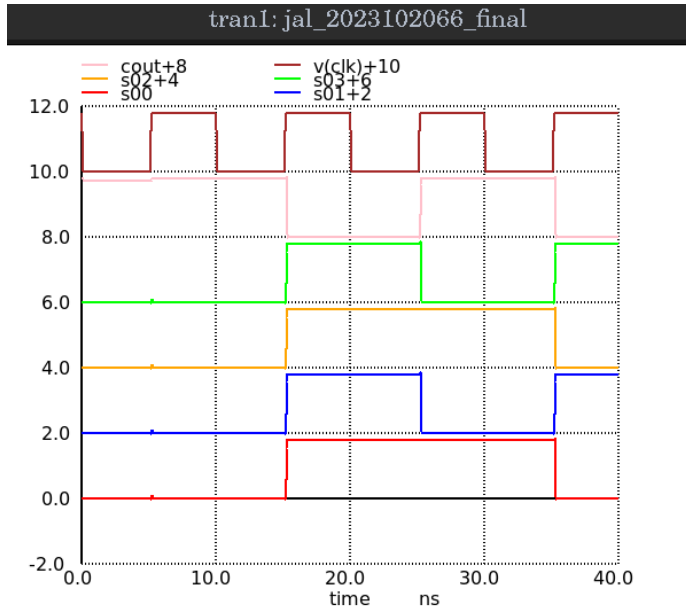


Fig. 59: Sum

## VII. VERILOG AND GTKWAVE SIMULATIONS

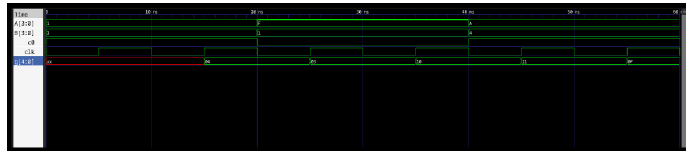


Fig. 60: GTKWave

```
VCD info: dumpfile cla_adder.vcd opened for output.
A=0001 B=0010 Cin=1 S=00100
A=1111 B=0001 Cin=0 S=10000
A=1010 B=0100 Cin=1 S=01111
```

Fig. 61: Terminal Results

## VIII. TIMING ANALYSIS

### A. Setup Time

1) *Prelayout and Postlayout Timing*: I found out setup time by changing input just before clock edge appeared. I continued to bring input close to clock edge and stopped when I didn't get desired output. The setup time for TSPC flipflop came out to be **0.135ns**.

The postlayout setup time came out to be **0.125ns**

### B. Hold Time

1) *Prelayout and Postlayout Timing*: Since I implemented TSPC flipflop logic and we know TSPC has 0 hold time so the hold time is **0ns**

### C. Clock to Q Delay

1) *Prelayout Timing and Postlayout Timing*: I found out Tpcq by measuring the delay between clock's positive edge and output change. I did it using  $T_{pcq}$  using:

```
meas tran clk_to_Q_delay trig v(clk) val=0.9
rise=1 targ v(Q) val=0.9 rise=1
```

$T_{pcq}$  came out to be 0.077 ns. Similarly the post layout simulation timing came out to be **0.086ns**.

### D. Adder Delay

1) *Prelayout Timing and Postlayout Timing*: For adder delay, I observed that output bit  $S_4$  had the maximum delay, and it came out to be 0.396 ns while going from 0 to 1 (rise) and 0.353 ns while going from 1 to 0 (fall). So for the worst-case scenario, I am considering **0.396 ns**.

Similarly, the post-layout simulation timing came out to be 0.571 ns while going from 0 to 1 (rise) and 0.638 ns while going from 1 to 0. Hence, for the worst-case scenario, I considered  $T_{pcq}$  as **0.638 ns**.

Command used for finding delay:

```
meas tran worst_case_delay trig v(A0) val=0.9
fall=1 targ v(S2) val=0.9 fall=1
```

### E. Maximum Clock Speed

$$T_{clk} \geq T_{su} + T_{pcq} + T_{pd}$$

$$T_{su} = 0.135 \text{ ns}$$

$$T_{pcq} = 0.077 \text{ ns}$$

$$T_{pd} = 0.396 \text{ ns}$$

$$T_{clk} \geq 0.135 + 0.077 + 0.396 \approx 0.608 \text{ ns}$$

$$f_{clk} \leq \frac{1}{T_{clk}}$$

$$\text{Maximum Frequency} = 1.6 \times 10^9 \text{ Hz}$$



For postlayout

$$T_{su} = 0.125 \text{ ns}$$

$$T_{pcq} = 0.0886 \text{ ns}$$

$$T_{pd} = 0.638 \text{ ns}$$

$$T_{clk} \geq 0.125 + 0.088 + 0.638 \approx 0.851 \text{ ns}$$

$$f_{clk} \leq \frac{1}{T_{clk}}$$

$$\text{Maximum Frequency} = 1.17 \times 10^9 \text{ Hz}$$

```
Reference value : 0.00000e+00
No. of Data Rows : 103
worst_case_delay = 3.839061e-10 targ= 1.039891e-08 trig= 1.001500e-08
```

Fig. 62: prelayout rise adder delay

```
Reference value : 1.19801e-08
No. of Data Rows : 108
worst_case_delay = 3.539885e-10 targ= 1.050399e-08 trig= 1.015000e-08
nnspace 11 -> □
```

Fig. 63: prelayout fall adder delay

```
v0#branch          0
va0#branch          0
vdd#branch          -9.11567e-10

Reference value : 0.00000e+00
No. of Data Rows : 87
worst_case_delay = 5.719386e-10 targ= 1.072194e-08 trig= 1.015000e-08
nnspace 6 -> □
```

Fig. 64: Postlayout rise adder delay

```
Reference value : 0.00000e+00
No. of Data Rows : 87
worst_case_delay = 6.385150e-10 targ= 6.885150e-10 trig= 5.000000e-11
nnspace 10 -> □
```

Fig. 65: Postlayout fall adder delay

## IX. REFERENCES

- 1) *Digital Logic and Computer Design* by Morris Mano
- 2) *Digital Integrated Circuits* by Jan M. Rabaey
- 3) GeeksforGeeks
- 4) DSM Slides of Aftab Sir